



D5V0FS4U10LP

#### **Product Summary**

V <sub>BR (Min)</sub>	IPP (Max)	Сио (тур)
5.5V	3.5A	0.45pF

#### Description

The D5V0FS4U10LP is a high-performance device suitable for protecting four high speed I/Os. These devices are assembled in U-DFN2510-10 package and have high ESD surge capability, low ESD clamping voltage and ultra-low capacitance.

# **Applications**

Typically used at high-speed ports such as USB 3.0, USB 3.1, Serial ATA, Display port.

#### 4 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

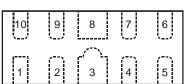
#### Features

- Clamping Voltage: 6V at 16A TLP
- IEC 61000-4-2 (ESD): Air ±8kV, Contact ±8kV
- IEC 61000-4-5 (Lightning): 3.5A (8/20µs)
- 4 Channels of ESD Protection
- Ultra-Low Channel Input Capacitance of 0.45pF Typical
- TLP Dynamic Resistance: 0.25Ω
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

## **Mechanical Data**

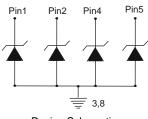
- Case: U-DFN2510-10
- Case Material: Molded Plastic, "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe (Lead Free Plating).
   Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.038 grams (Approximate)

# Pin # Description 1, 2, 4, 5 I/O 6, 7, 9, 10 No Connection 3, 8 Vss



U-DFN2510-10

Pin Description (Top View)



#### **Device Schematic**

## Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity
D5V0FS4U10LP-7	Standard	NZ1	7	8	3,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**

Notes:



3

4

U-DFN2510-10

8

9

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Date Code Key												
Year	20	17	20	18	20	19	20	20	20	)21	20	22
Code	E			-	(	G	ŀ	4				J
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

5

2

Code

6

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Ν



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current, per IEC 61000-4-5	IPP	3.5	А	I/O to V <sub>SS</sub> , 8/20µs
Peak Pulse Power, per IEC 61000-4-5	P <sub>PP</sub>	20	W	I/O to V <sub>SS</sub> , 8/20µs
ESD Protection – Contact Discharge, per IEC 61000-4-2	V <sub>ESD_CONTACT</sub>	±8	kV	I/O to V <sub>SS</sub>
ESD Protection – Air Discharge, per IEC 61000-4-2	$V_{ESD_{AIR}}$	±8	kV	I/O to V <sub>SS</sub>

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation Typical (Note 5)	PD	350	mW
Thermal Resistance, Junction to Ambient Typical (Note 5)	R <sub>0JA</sub>	360	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 to +150	°C

#### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V <sub>RWM</sub>	—	—	5	V	—
Reverse Current	I <sub>R</sub>	—	—	1	μA	$V_R = 5V$ , I/O to $V_{SS}$
Reverse Breakdown Voltage	V <sub>BR</sub>	5.5	7.0	_	V	$I_R = 1mA$ , I/O to V <sub>SS</sub>
Forward Clamping Voltage	VF	-1.0	-0.85	_	V	$I_F = -15 \text{mA}$ , I/O to $V_{SS}$
Holding Reverse Voltage	V <sub>HOLD</sub>	—	1.19	-	V	I/O to V <sub>SS</sub>
Holding Reverse Current	I <sub>HOLD</sub>	—	90	-	mA	I/O to V <sub>SS</sub>
Reverse Clamping Voltage (Note 6)	Vc	—	3		V	I <sub>PP</sub> = 3A, I/O to V <sub>SS</sub> , 8/20µs
Clamping Voltage (Note 7)	Vc	—	6		V	TLP, 16A, tp = 100ns, I/O to $V_{SS}$
Clamping Voltage (Note 7)	Vc	—	4.5		V	TLP, -16A, tp = 100ns, I/O to $V_{SS}$
Dynamic Reverse Resistance	R <sub>DIF-R</sub>	—	0.25	_	Ω	TLP, 10A, tp = 100ns, I/O to $V_{SS}$
Dynamic Forward Resistance	R <sub>DIF-F</sub>	—	0.2		Ω	TLP, 10A, tp = 100ns, V <sub>SS</sub> to I/O
Channel Input Capacitance	C <sub>I/O</sub>	_	0.45	_	pF	$V_{I/O} = 0V, V_{SS} = 0V, f = 1MHz$

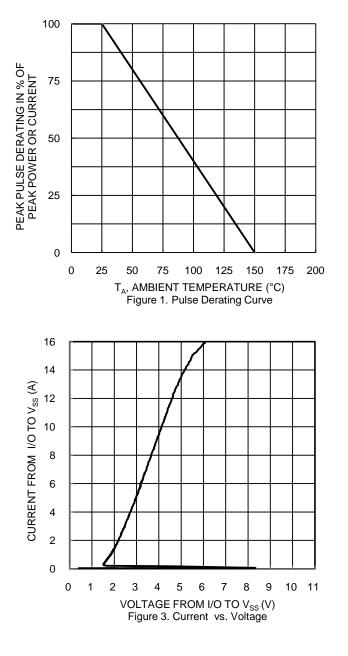
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

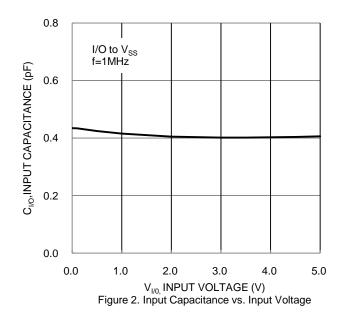
6. Clamping voltage value is based on an  $8x20\mu s$  peak pulse current (IPP) waveform.

7. Clamping voltage value is based on an TLP model. TLP conditions:  $Z_0=50\Omega$ , tp = 100ns, averaging window; t1=70ns to t2=90ns.



# D5V0FS4U10LP



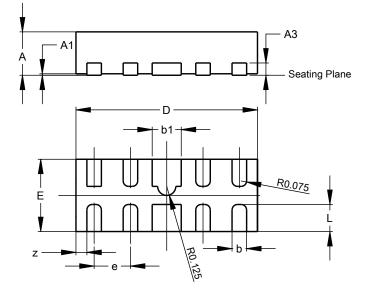




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

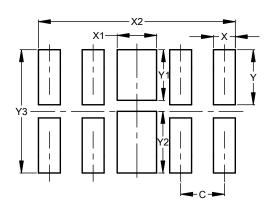
#### U-DFN2510-10



L L	U-DFN2510-10							
Dim	Min Max Ty							
Α	0.545	0.605	0.575					
A1	0.00	0.05	0.03					
A3	-	-	0.13					
b	0.15	0.25	0.20					
b1	0.35	0.45	0.40					
D	2.450	2.575	2.500					
е	-	-	0.50					
Е	0.950	1.075	1.000					
L	0.325	0.425	0.375					
z	-	-	0.150					
All D	All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



#### U-DFN2510-10

Dimensions	Value (in mm)
C	0.500
Х	0.250
X1	0.450
X2	2.250
Y	0.625
Y1	0.575
Y2	0.700
Y3	1.400

D5V0FS4U10LP Document number: DS39520 Rev. 1 - 2



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